## NEW UTILITY PATENT APPLICATION TRANSMITTAL

DOCKET NO. END920030018US1 (END-10-5765)

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### TO THE ASSISTANT COMMISSIONER FOR PATENTS

Box Patent Application Washington, D.C. 20231

Transmitted herewith for filing under 35 USC 111(a) and 37 CFR 1.53(b) is a new utility patent application for an invention entitled: METHOD OF FORMING A BOND PAD ON AN I/C CHIP AND RESULTING STRUCTURE invented by: JULIE C. BIGGS ROGER A. QUON JONATHAN H. GRIFFITH **WOLFGANG SAUTER** TIEN-JEN CHENG RANDOLPH F. KNARR SARAH H. KNICKERBOCKER KAMALESH K. SRIVASTAVA DAVID E. EICHSTADT KEVIN S. PETRARCA RICHARD P. VOLANT LISA A. FANTI assigned to INTERNATIONAL BUSINESS MACHINES CORPORATION Armonk, New York If a CONTINUATION APPLICATION, check appropriate box and supply the requisite information: **Divisional** Continuation -in -part (CIP) Continuation in prior application No.: Enclosed are: **Application Elements** Filing fee as calculated and transmitted as described below 冈 1. 2. Ø Specification having 11 pages and including the following: Descriptive Title of the Invention a. Cross References to Related Applications (if applicable) b. Statement Regarding Federally-sponsored Research/Development (if applicable) c. Reference to Microfiche Appendix (if applicable) d. Background of the Invention e. f. Brief Summary of the Invention Brief Description of the Drawings (if drawings filed) g. **Detailed Description** h. Claim(s) as Classified Below i. Abstract of the Disclosure j. 冈 Drawing(s) (when necessary as prescribed by 35 USC 113) 3.



a. b. Formal

Informal

Number of Sheets 4

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4.	a. b.	Oath or Declaration  Newly executed (original or copy)  Copy from a prior application (37 CFR 1.63(d)) (for continuation/divisional
	c.	application only)  ☑ With Power of Attorney ☐ Without Power of Attorney
		Application Elements (Continued)
5.		Incorporation by Reference (usable if Box 4b is checked)  The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied under Box 4b, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.
6.		Computer Program in Microfiche (Appendix)
7.	a. b. c.	Nucleotide and/or Amino Acid Sequence Submission (if applicable, all must be included)  Paper Copy Computer Readable Copy (identical to computer copy) Statement Verifying Identical Paper and Computer Readable Copy
		Accompanying Application Parts
8.	$\boxtimes$	Assignment Papers (cover sheet & document(s)) International Business Machines Corporation, Armonk, NY
9.		37 CFR 3.73(B) Statement (when there is an assignee)
10.	. 🗆	English Translation Document (if applicable)
11.	. 🛛	Information Disclosure Statement/PTO-1449
12.	. 🗆	Preliminary Amendment
13.	. 🛛	Return Receipt Postcard
14.	. 🛛	Certificate of Mailing  First Class Express Mail (Specify Label No.): ET808936165US
15.	. 🛛	Application Data Sheet
16.	. 🗆	Additional Enclosures (please identify below):

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#### FEE CALCULATION AND TRANSMITTAL

#### **CLAIMS AS FILED** 2) Number Filed 3) Number Extra 1) For Rate Additional Fee TOTAL CLAIMS 17 - 20 = - 0 x\$18.00 - 0 -(37 CFR 1.16(c)) INDEPENDENT CLAIMS (37 CFR 1.16(c)) 2 - 3 =- 0 x 84.00 - 0 -First Pres. Of Multiple Dep. Claims x 280.00 = 0\$ 0.00 Basic Fee \$ 750.00 **TOTAL** \$ 750.00 A check in the amount of to cover the filing fee is enclosed. The Commissioner is hereby authorized to charge and credit Deposit Account No. 09-0457 as described below. A duplicate copy of this sheet is enclosed. Charge the amount of \$750.00 as filing fee. Credit any overpayment or any deficiency. Charge any additional filing fees required under 37 CFR 1.16 and 1.17. Respectfully submitted, William H. Steinberg, Reg. No. 28,540 **IBM** Corporation Intellectual Property Law 1Q0A/040-3 1701 North Street Endicott, NY 13760

**(607) 429** - 3979

DOCKET NO. CERTIFICATE OF MAILING BY "EXPRESS MAIL" (37 CFR 1.10) END920030018US1 Applicant(s): Biggs et al (END-10-5765) Group Art Unit Filing Date Examiner Serial No. Filed Herewith To be assigned METHOD OF FORMING A BOND PAD ON AN I/C CHIP Invention: AND RESULTING STRUCTURE I hereby certify that the following documents New Utility Patent Application Transmittal **Application Data Sheet** Patent Application comprising 6 pages of specification, 4 pages of claims, 1 page of Abstract and 4 sheet of drawings Declaration and Power of Attorney for Patent Application Assignment and Recordation Cover Sheet IDS Submission Statement with 1449 Form and copies of all citations (Abn us) Two (2) Acknowledgement post cards are being deposited with the United States Postal Service "Express Mail Post Office to Addressee" service under 37 CFR 1.10 in an envelope addressed to: Mail Stop Patent Application, Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450, on 9/18/03 Georgia Y. Brundege Typed or Printed Name of Person Mailing Correspondence) Mailing Correspondence) ET808936165US ("Express Mail" Mailing Label Number)